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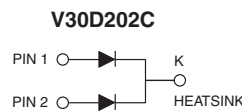
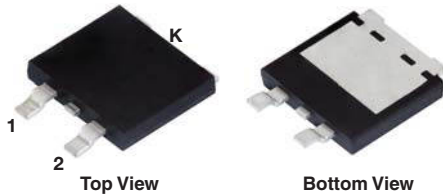
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Dual High-Voltage Trench MOS Barrier Schottky Rectifier

TMBS® eSMP® Series TO-263AC (SMPD)



RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Trench MOS Schottky technology generation 2
- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

MECHANICAL DATA

Case: TO-263AC (SMPD)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 15.0 A
V_{RRM}	200 V
I_{FSM}	260 A
V_F at $I_F = 15.0$ A ($T_A = 125$ °C)	0.66 V
T_J max.	175 °C
Package	TO-263AC (SMPD)
Diode variations	Dual common cathode

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V30D202C	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	200	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	per device	30
		per diode	15
Maximum DC reverse voltage	V_{DC}	160	V
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	260	A
Voltage rate of change (rated V_R)	dV/dt	10 000	V/ μ s
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +175	°C

ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage per diode	$I_F = 5\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.72	-	V
	$I_F = 10\text{ A}$			0.78	-	
	$I_F = 15\text{ A}$			0.8	0.88	
	$I_F = 5\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.56	-	
	$I_F = 10\text{ A}$			0.64	-	
	$I_F = 15\text{ A}$			0.66	0.73	
Reverse current at rated V_R per diode	$V_R = 160\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	1	-	μA
		$T_A = 125\text{ }^\circ\text{C}$		2	-	mA
	$V_R = 200\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$		-	200	μA
		$T_A = 125\text{ }^\circ\text{C}$		5	25	mA

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
 (2) Pulse test: Pulse width $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)				
PARAMETER		SYMBOL	V30D202C	UNIT
Typical thermal resistance	per diode	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
	per device		1.1	
	per device	$R_{\theta JA}^{(1)(2)}$	50	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$ - junction-to-mount
 (2) Free air, without heatsink

ORDERING INFORMATION (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TO-263AC (SMPD)	V30D202C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel
TO-263AC (SMPD)	V30D202CHM3/I ⁽¹⁾	0.55	I	2000/reel	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

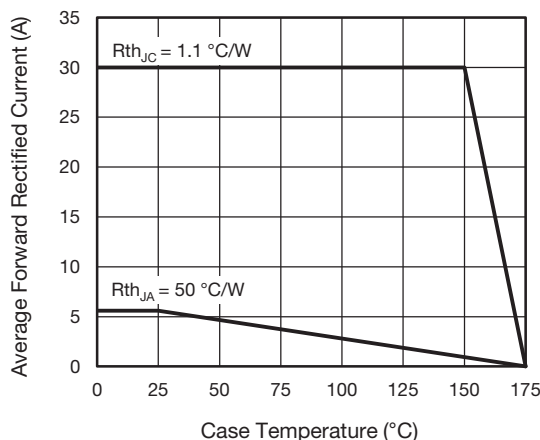
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)


Fig. 1 - Forward Current Derating Curve

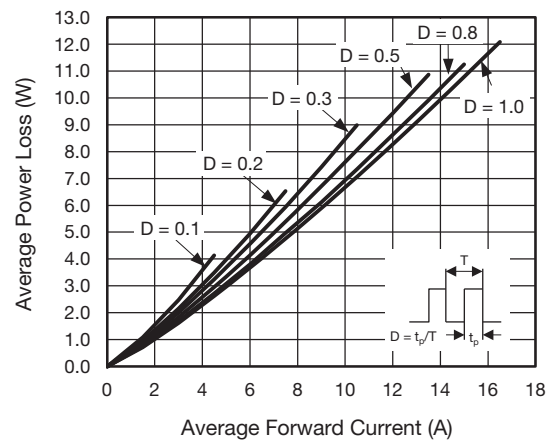


Fig. 2 - Forward Power Loss Characteristics

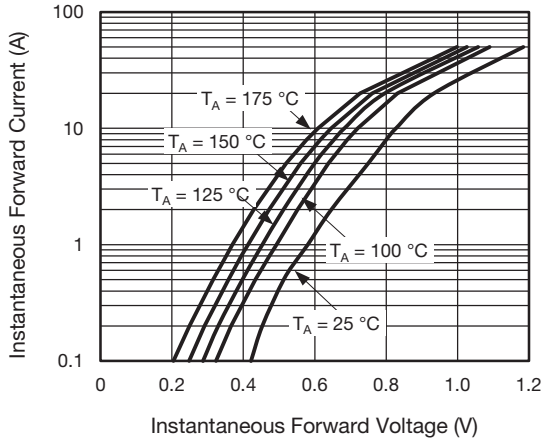


Fig. 3 - Typical Instantaneous Forward Characteristics

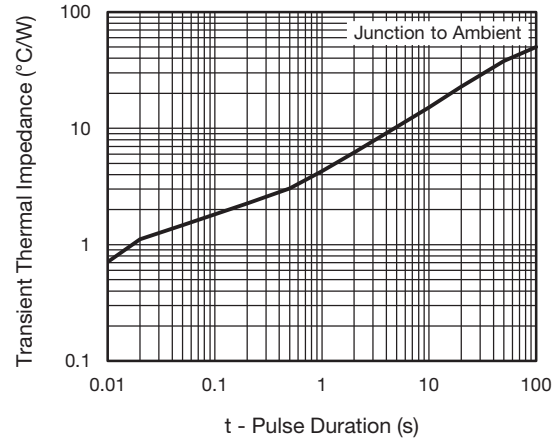


Fig. 6 - Typical Transient Thermal Impedance

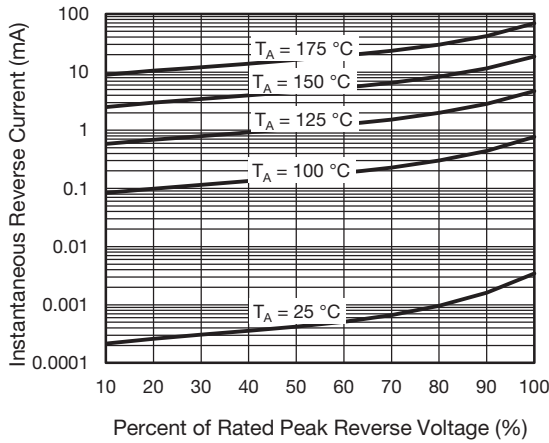


Fig. 4 - Typical Reverse Characteristics

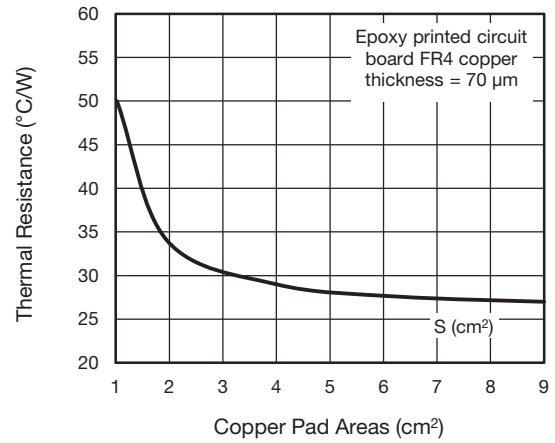


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

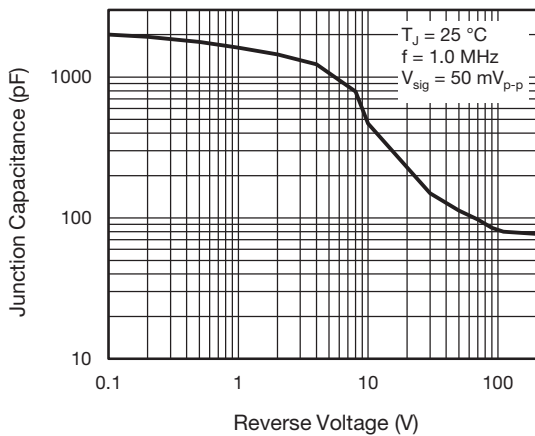
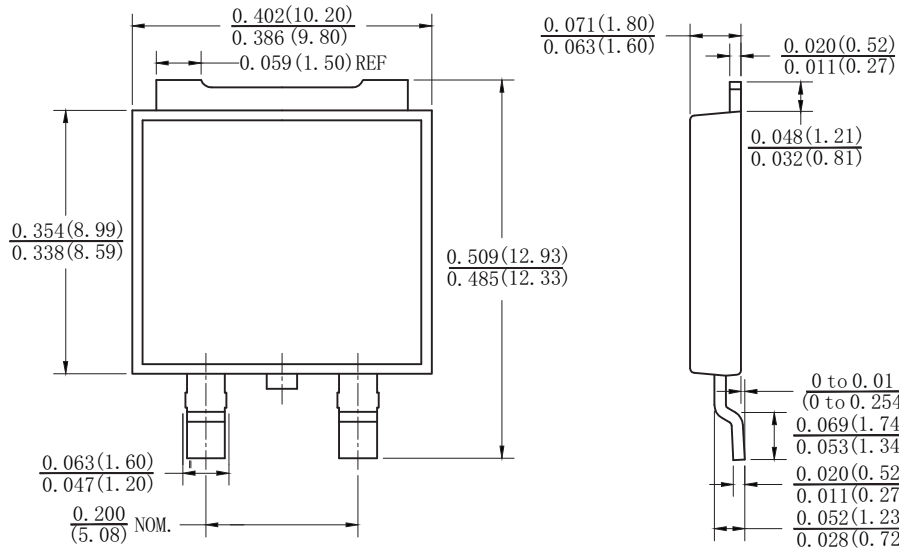


Fig. 5 - Typical Junction Capacitance

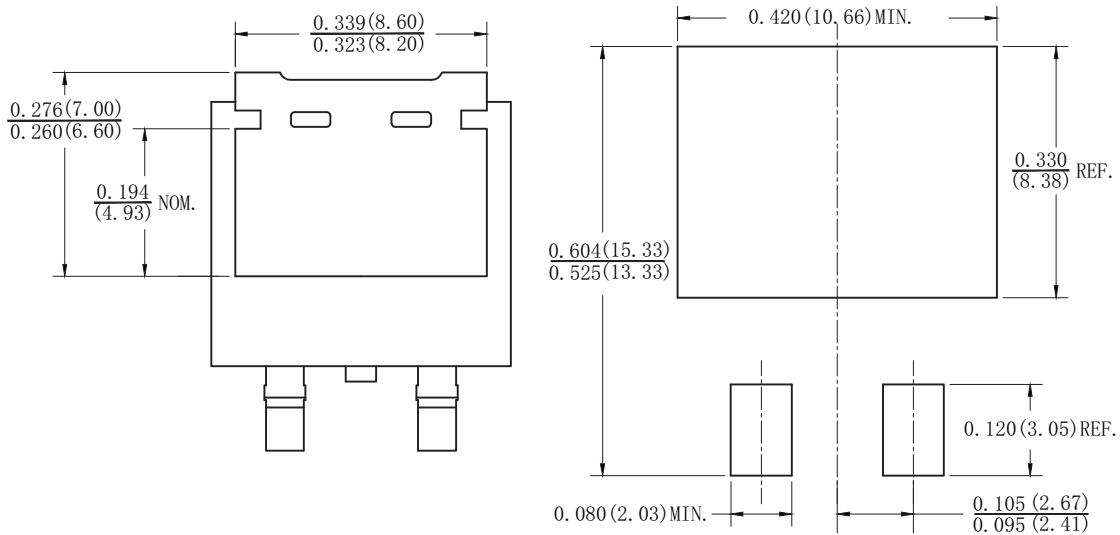


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

TO-263AC (SMPD)



Mounting Pad Layout





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